Variant Key:

Variant 001 has an isolated RS-485 interface and a Fly-Buck power supply with an isolated secondary.
Variant 002 has a non-isolated RS-485 interface and a simple Buck power supply.

ISE4033 and ISE4037 are the same design and were split at revision E2.
ISOLATED TRANSCEIVER

NON-ISOLATED TRANSCEIVER
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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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